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SPECIFICATION

PRODUCT: SAW FILTER

MODEL: HDAF38A3D



SHOULDER ELECTRONICS LIMITED

1.SCOPE

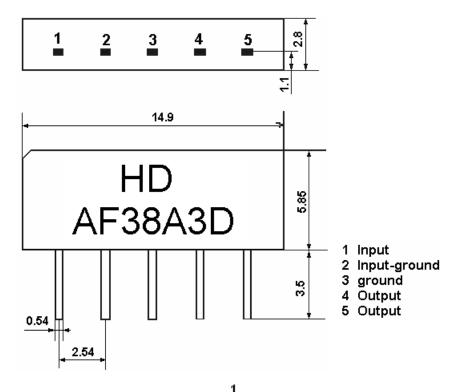
SHOULDER'S SAW filter series have broad line up products meeting all broadcast standard including NTSC,PAL and SECAM systems. These filters are composed of two interdigital transducers on a single-crystal. piezoelectrical chip. they are used in electronic equipments such as TV and so on.

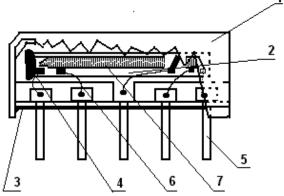
2. Construction

2.1 Dimension and materials

Manufacturer's name: SHOULDER ELECTRONICS Co. LTD(CHINA)

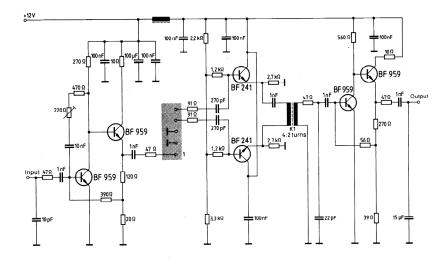
Type: AF38A3D





Components	Materials
1.Outer casing	PPS
2.Substrate	Lithium niobate
3.Base	Epoxy resin
4.Absorber	Epoxy resin
5.Lead	Cu alloy+Au plate
6.Bonding wire	AlSi alloy
7.Electrode	Al

2.2. Circuit construction, measurement circuit



Test circuit for SIP-5 filter Input impedance of the symmetrical post-amplifier: 2 k Ω in parallel with 3 pF

3. Characteristics

Items	Conditions	Specifications
Standard atmospheric conditions	Unless otherwise specified, the standard rang of atmospheric conditions for making measurements and tests is as follows; Ambient temperature : 15°C to 35°C Relative humidity : 25% to 85% Air pressure : 86kPa to 106kPa	
Operating temperature rang	Operating temperature rang is the rang of ambient temperatures in which the filter can be operated continuously. $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$	There shall be no damage.
Storage temperature rang	Storage temperature rang is the rang of ambient temperatures at which the filter can be stored without damage. Conditions are as specified elsewhere in these specifications. $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$	
Reference temperature	+25°C	

3.1 Maximum Rating

DC voltage	VDC	12	${f V}$	Between any terminals
AC voltage	Vpp	10	${f V}$	Between any terminals

3.2 Electrical Characteristics

Source impedance $Zs=50 \Omega$

Item		Freq	min	typ	max	
Insertion attenuation Reference level		31.50MHz	10.5	12.0	13.5	dB
		31.45MHz	-1.0	0.0	1.0	dB
		32.00MHz	-0.9	0.1	1.1	dB
		32.50MHz	0.1	1.1	2.1	dB
		38.00MHz	40.0	48.0	-	dB
Relative att	enuation	33.57MHz	30.0	37.0	-	dB
		30.00MHz	40.0	52.0	-	dB
		39.50MHz	42.0	58.0	-	dB
		40.00MHz	42.0	62.0	-	dB
		40.50MHz	42.0	60.0	-	dB
Sidelobe	25.00~	30.00MHz	37.0	41.0		dB
Sidelobe	38.00~45.00MHz		40.0	45.0	-	dB
Temperature coefficient				-72	•	ppm/k

3.3Environmental Performance Characteristics

Item	Conditi	Specifications				
High	The specimen shall be store	re at a temperature of				
temperature	80±2°C for 96±4h. Then	2°C for 96±4h. Then it shall be subjected to				
	-	d atmospheric conditions for 1h, after				
	which measurement shall be	e made within 1h.				
Low	The specimen shall be stor	re at a temperature of				
temperature	-20±3°C for 96±4h. Then	it shall be subjected to				
	standard atmospheric con					
TT '1'4	which measurement shall be		<u> </u>			
Humidity	The specimen shall be stored	-				
	40±2°C with relative hum	•				
	for 96±4h. Then it shall be	•	3.6 1 ' 1			
	atmospheric conditions f		characteristics and			
TT1 1	measurement shall be made		- · · · · · · · ·			
Thermal	The specimen shall be sub-		, 1 - 4 - 1			
shock	cycles each as shown bel subjected to standard atmo		, , , , , , , , , , , , , , , , , , , ,			
	1h, after which measure		1			
	within 1h.	ment shan be made	shall be no			
	Temperature	Duration	excessive change in			
	$\begin{array}{ c c c c }\hline 1 & +25^{\circ}C = > -40^{\circ}C \\ \hline \end{array}$	0.5h	appearance.			
	2 -40°C	4h				
	3 -40°C=>+85°C	-40°C=>+85°C 2h				
	4 +85°C	+85℃ 4h				
	5 +85°C=>+25°C	+85°C=>+25°C 0.5h				
	6 +25°C	6 +25°C 1h				
Resistance to	Reflow soldering method					

Soldering	Peak: 255 ±5 °C, 220 ±5 °C, 40s	
heat		
neat	At electrode temperature of the specimen.	
	Temperature profile of reflow soldering Soldering 250 200 Pre-heating 150 Pre-heating 50 100 Slow cooling (Store at room temperature)	
	1 to 2 min. 10s 2 min. or more	
	The specimen shall be passed through the reflow	
	furnace with the condition shown in the above	
	profile for 1 time.	
	The specimen shall be stored at standard	
	atmospheric conditions for 1h, after which the measurement shall be made. Test board shall be	
	1.6 mm thick. Base material shall be glass fabric base epoxy resin.	
Solder ability	· · ·	More then 95% of
Solder ability	Immerse the pins melt solder at $260^{\circ}\text{C}+5/-0^{\circ}\text{C}$ for 5 sec.	total area of the
	101 3 860.	pins should be
		covered with solder

3.4Mechanical Test

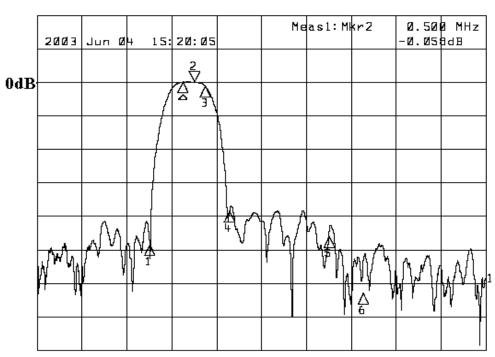
Items	Conditions	Specifications
Vibration	600-3300rpm amplitude 1.5mm	
	3 directions 2 H each	
Drop	On maple plate from 1m high 3 times	
		There shall be no
Lead pull	Pull with 1kg force for 30 seconds	damage.
Lead bend	90° bending with 500g weigh 2 times	

3.5Voltage Discharge Test

Item	Condition	Specifications
Surge	Between any two electrode	
	T100V T000pF 4Mohm	There shall be no damage

3.6 Frequency response

▶1:Transmission /M Log Mag 10.0 dB/



Start 25.000 MHz

Stop 45.000 MHz

1: M	kr∆(MHz)	dВ	2: Mkr	(MHz)	dВ	
1:	-1.5000	-48.713				
2>	0.5000	-0.058				
3:	1.0000	-1.273				
4:	2.0700	-38.804				
5:	6.5000	-46.201				
6:	8.0000	-63.179				
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